

# Specification for Approval

Date: 2023/06/02

Customer : \_\_\_\_\_

TAI-TECH P/N: APO322523NV-SERIES-HD

CUSTOMER P/N: \_\_\_\_\_

DESCRIPTION: \_\_\_\_\_

QUANTITY: \_\_\_\_\_ pcs

REMARK:		
Customer Approval Feedback		

**西北臺慶科技股份有限公司**  
**TAI-TECH Advanced Electronics Co., Ltd**

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## Winding Type Chip Inductor

APO322523NV-SERIES-HD

## ECN HISTORY LIST

REV	DATE	DESCRIPTION	APPROVED	CHECKED	DRAWN
1.0	23/06/02	新發行	楊祥忠	徐鋒強	何玉蓮
備 註					

# Winding Type Chip Inductor

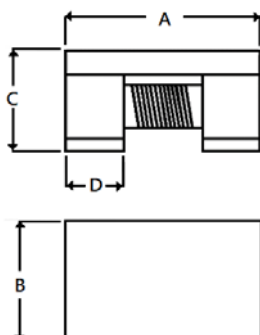
APO322523NV-SERIES-HD

## 1. Features

1. Ferrite core wire wound construction.
2. High Reliability due to wire wound type construction.
3. Small footprint as well as low profile.
4. 100% Lead(Pb) & Halogen-Free and RoHS compliant.
5. High reliability -Reliability tests comply with AEC-Q200
6. Operating temperature-55~+150°C(Including self - temperature rise)
7. Inductor for use in-vehicle PoC (Power Over Coax)



## 2. Dimension



Size	A	B	C	D
APO3225	3.20±0.20	2.50±0.20	2.30±0.20	0.58±0.10

Unit:mm

## 3. Part Numbering



- A: Series  
 B: Dimension L x W x H  
 C: Application  
 D: Category Code V=Vehicle  
 E: Inductance 470=47.0uH  
 F: Inductance Tolerance M=±20%  
 G: Control S/N

## 4. Specification

TAI-TECH Part Number	Ls(μH) (@1 MHz)	DCR (Ω) Max.	SRF (MHz min.)	Rated current(mA)			
				Isat(mA)	Based on temperature rise		
					Ambient temperature 85°C	Ambient temperature 105°C	Ambient temperature 125°C
APO322523NV-2R2M-HD	2.2 ±20%	0.19	200	1000	1000	880	520
APO322523NV-2R7M-HD	2.7 ±20%	0.22	200	975	975	860	510
APO322523NV-3R3M-HD	3.3 ±20%	0.24	150	950	950	840	500
APO322523NV-4R7M-HD	4.7 ±20%	0.28	100	850	850	720	400
APO322523NV-100M-HD	10.0 ±20%	0.40	100	500	700	620	360
APO322523NV-220M-HD	22.0 ±20%	0.62	50	400	550	500	280
APO322523NV-470M-HD	47.0 ±20%	0.90	30	300	500	300	100

Note:

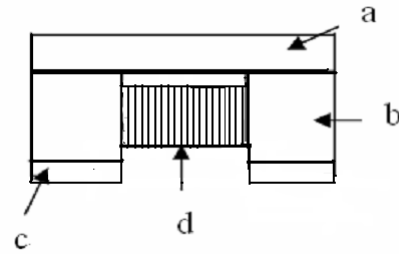
Isat: Applied the current to coils, the inductance change shall be less than 30% of initial value.

Ambient temperature (85°C/105°C): the part temperature (ambient temperature plus self-generation of heat) should be under 150°C.

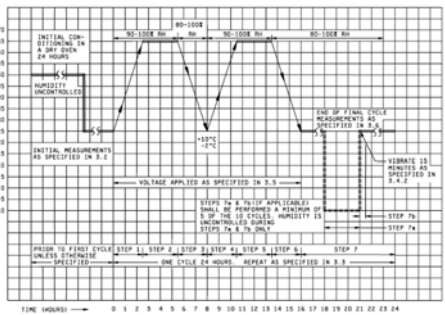
Ambient temperature (125°C):the part temperature (ambient temperature plus self-generation of heat) should be under 150°C.

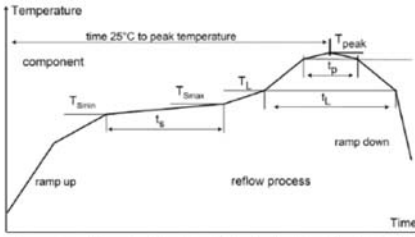
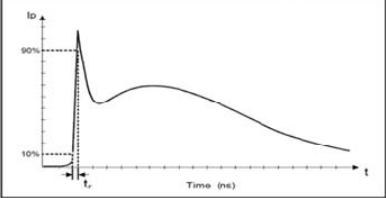
## 5. Materials

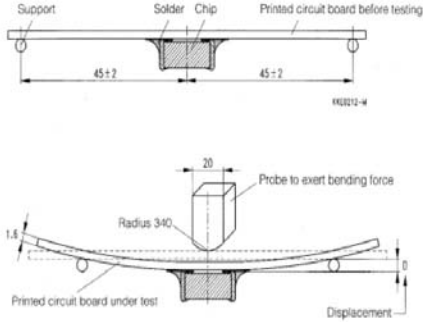
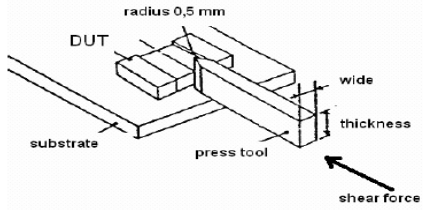
No.	Description	Specification
a.	Upper plate	Ferrite
b.	Core	Ferrite Core
c.	Termination	Ag/Ni/Sn
d.	Wire	Enameled Copper Wire



### 6. Reliability and Test Condition

Item	Performance	Test Condition															
Operating temperature	-55~+150°C (Including self - temperature rise)																
Storage temperature	-55~+125°C (on board)																
<b>Electrical Performance Test</b>																	
Inductance L	Refer to standard electrical characteristic list	Agilent E4991A , Keysight E4991B ,Keysight 4980AL Agilent-4287, Agilent-4285															
DC Resistance		Agilent-34420A Agilent-4338B															
Isat	$\Delta L \leq 30\%$	Applied the current to coils, the inductance change shall be less than 30% to initial value.															
Irms	$\Delta T \leq 40^\circ\text{C}$	Heat Rated Current (Irms) will cause the coil temperature rise $\Delta T(^{\circ}\text{C})$ without core loss. 1.Applied the allowed DC current. 2.Temperature measured by digital surface thermometer															
<b>Reliability Test</b>																	
High Temperature Exposure(Storage) AEC-Q200	Appearance : No damage. Inductance : within $\pm 10\%$ of initial value RDC : within $\pm 15\%$ of initial value and shall not exceed the specification value	Preconditioning: Run through reflow for 3 times.( IPC/JEDEC J-STD-020E Classification Reflow Profiles Temperature : $150\pm 2^\circ\text{C}$ Duration : 1000hrs Min. Measured at room temperature after placing for 24 $\pm 4$ hrs.															
Temperature Cycling AEC-Q200		Preconditioning: Run through reflow for 3 times.( IPC/JEDEC J-STD-020E Classification Reflow Profiles Condition for 1 cycle Step1 : $-55\pm 2^\circ\text{C}$ 30min Min. Step2 : $150\pm 2^\circ\text{C}$ transition time 1min MAX. Step3 : $150\pm 2^\circ\text{C}$ 30min Min. Step4 : Low temp. Transition time 1min MAX. Number of cycles : 1000 Measured at room temperature after placing for 24 $\pm 4$ hrs.															
Moisture Resistance (AEC-Q200)		t=24 hours/cycle. Note: Steps 7a & 7b not required. Unpowered. Measurement at 24 $\pm 2$ hours after test conclusion.															
																	
Biased Humidity (AEC-Q200)		Preconditioning: Run through reflow for 3 times.( IPC/JEDEC J-STD-020E Classification Reflow Profiles Humidity : $85\pm 3\%$ R.H, Temperature : $85^\circ\text{C} \pm 2^\circ\text{C}$ Duration: 1000hrs Min. Measured at room temperature after placing for 24 $\pm 4$ hrs															
High Temperature Operational Life (AEC-Q200)		Preconditioning: Run through reflow for 3 times.( IPC/JEDEC J-STD-020E Classification Reflow Profiles Temperature : $150\pm 2^\circ\text{C}$ Duration : 1000hrs Min. with 100% rated current. Measured at room temperature after placing for 24 $\pm 4$ hrs															
External Visual	Appearance : No damage.	Inspect device construction, marking and workmanship. Electrical Test not required.															
Physical Dimension	According to the product specification size measurement	According to the product specification size measurement															
Resistance to Solvents		Add aqueous wash chemical - OKEM clean or equivalent.															
Mechanical Shock	Appearance : No damage. Inductance : within $\pm 10\%$ of initial value RDC : within $\pm 15\%$ of initial value and shall not exceed the specification value	<table border="1"> <thead> <tr> <th>Type</th> <th>Peak value (g's)</th> <th>Normal duration (D) (ms)</th> <th>Wave form</th> <th>Velocity change (Vi)ft/sec</th> </tr> </thead> <tbody> <tr> <td>SMD</td> <td>100</td> <td>6</td> <td>Half-sine</td> <td>12.3</td> </tr> <tr> <td>Lead</td> <td>100</td> <td>6</td> <td>Half-sine</td> <td>12.3</td> </tr> </tbody> </table> <p>3 shocks in each direction along 3 perpendicular axes. (18 shocks).</p>	Type	Peak value (g's)	Normal duration (D) (ms)	Wave form	Velocity change (Vi)ft/sec	SMD	100	6	Half-sine	12.3	Lead	100	6	Half-sine	12.3
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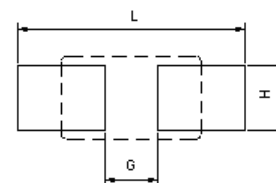
Item	Performance	Test Condition																																																															
Vibration		IPC/JEDEC J-STD-020E Classification Reflow Profiles Oscillation Frequency:10Hz~2KHz~10Hz for 20 minute Equipment : Vibration checker Total Amplitude:5g Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations) .																																																															
Resistance to Soldering Heat	Appearance : No damage. Inductance : within±10% of initial value RDC : within ±15% of initial value and shall not exceed the specification value	Test condition : <table border="1" data-bbox="914 389 1362 483"> <thead> <tr> <th>Temperature(°C)</th> <th>Time(s)</th> <th>Temperature ramp/immersion and emersion rate</th> <th>Number of heat cycles</th> </tr> </thead> <tbody> <tr> <td>260 ±5 (solder temp)</td> <td>10 ±1</td> <td>25mm/s ±6 mm/s</td> <td>1</td> </tr> </tbody> </table> Depth: completely cover the termination Continental  <table border="1" data-bbox="903 797 1406 983"> <thead> <tr> <th>Component Size</th> <th>Ramp up to 150°C</th> <th>T<sub>soak</sub></th> <th>t<sub>1</sub></th> <th>T<sub>max</sub></th> <th>T<sub>1</sub></th> <th>t<sub>2</sub></th> <th>T<sub>min</sub></th> <th>t<sub>3</sub></th> <th>time 25°C to peak</th> <th>Ramp down</th> </tr> </thead> <tbody> <tr> <td>Thickness = 1.5mm or less and Volume &lt; 350 mm<sup>3</sup></td> <td>3.000 °C/s</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>340s</td> </tr> <tr> <td>Thickness = 1.5mm-2.5mm and Volume &lt; 350-1000 mm<sup>3</sup></td> <td>3.000 °C/s</td> <td>±150° C</td> <td>≥110s</td> <td>≥200°C</td> <td>≥217°C</td> <td>≥50s</td> <td>≥250°C</td> <td></td> <td></td> <td>330s</td> </tr> <tr> <td>Thickness = 2.5mm and Volume &lt; 350 mm<sup>3</sup></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>≥240°C</td> <td></td> <td></td> <td>330s</td> </tr> <tr> <td>Thickness = 1.5mm-2.5mm and Volume &lt; 2000 mm<sup>3</sup> or Thickness &gt; 2.5mm and Volume &lt; 100 mm<sup>3</sup></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>≥240°C</td> <td></td> <td></td> <td>330s</td> </tr> </tbody> </table>	Temperature(°C)	Time(s)	Temperature ramp/immersion and emersion rate	Number of heat cycles	260 ±5 (solder temp)	10 ±1	25mm/s ±6 mm/s	1	Component Size	Ramp up to 150°C	T <sub>soak</sub>	t <sub>1</sub>	T <sub>max</sub>	T <sub>1</sub>	t <sub>2</sub>	T <sub>min</sub>	t <sub>3</sub>	time 25°C to peak	Ramp down	Thickness = 1.5mm or less and Volume < 350 mm <sup>3</sup>	3.000 °C/s									340s	Thickness = 1.5mm-2.5mm and Volume < 350-1000 mm <sup>3</sup>	3.000 °C/s	±150° C	≥110s	≥200°C	≥217°C	≥50s	≥250°C			330s	Thickness = 2.5mm and Volume < 350 mm <sup>3</sup>							≥240°C			330s	Thickness = 1.5mm-2.5mm and Volume < 2000 mm <sup>3</sup> or Thickness > 2.5mm and Volume < 100 mm <sup>3</sup>							≥240°C			330s
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Thermal shock (AEC-Q200)		Preconditioning: Run through reflow for 3 times.( IPC/JEDEC J-STD-020E Classification Reflow Profiles Condition for 1 cycle Step1 : -55±2°C 15±1min Step2 : 150±2°C within 20Sec. Step3 : 150±2°C 15±1min Number of cycles : 300 Measured at room temperature after placing fo24±4hrs																																																															
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ESD	Appearance : No damage. Inductance : within±10% of initial value RDC : within ±15% of initial value and shall not exceed the specification value	 Direct Contact and Air Discharge PASSIVE COMPONENT HBM ESD Discharge Waveform to a Coaxial Target Test method: AEC-Q200-002 Test mode : Contact Discharge Discharge level : 4 KV (Level: 2 )																																																															
Solderability	More than 95% of the terminal electrode should be covered with solder .	a. Method B, 4 hrs @155°C dry heat @235°C±5°C Testing Time :5 +0/-0.5 seconds b. Method D category 3. (8hours ± 15 min)@ 260°C±5°C Testing Time :30 +0/-0.5 seconds																																																															
Electrical Characterization	Refer Specification for Approval	Summary to show Min, Max, Mean and Standard deviation.																																																															
Flammability	Electrical Test not required.	V-0 or V-1 are acceptable.																																																															

Item	Performance	Test Condition
<p>Board Flex</p>	<p>Appearance : No damage.                      Inductance : within±10% of initial value                      RDC : within ±15% of initial value and shall not exceed the specification value</p>	<p>Preconditioning: Run through reflow for 3 times.( IPC/JEDEC J-STD-020E Classification Reflow Profiles                      Place the 100mm X 40mm board into a fixture similar to the one shown in below Figure with the component facing down. The apparatus shall consist of mechanical means to apply a force which will bend the board (D) x = 2 mm minimum. The duration of the applied forces shall be 60 (+ 5) sec. The force is to be applied only once to the board.</p> 
<p>Terminal Strength(SMD)</p>	<p>Appearance : No damage.                      Inductance : within±10% of initial value                      RDC : within ±15% of initial value and shall not exceed the specification value</p>	<p>Preconditioning: Run through reflow for 3 times.( IPC/JEDEC J-STD-020E Classification Reflow Profiles                      With the component mounted on a PCB with the device to be tested, apply a 17.7 N (1.8 Kg) force to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.</p> 

## 7. Soldering and Mounting

### 7-1. Recommended PC Board Pattern

Land Patterns For Reflow Soldering								
Series	Type	A(mm)	B(mm)	C(mm)	D(mm)	L(mm)	G(mm)	H(mm)
APO	322523	3.20±0.20	2.50±0.20	2.30±0.20	0.58±0.10	3.80	2.20	2.80



### 7-2. Soldering

Mildly activated rosin fluxes are preferred. TAI-TECH terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

#### 7-2.1 Soldering Reflow:

Recommended temperature profiles for lead free re-flow soldering in Figure 1. Table 1.1&1.2 (J-STD-020E)

#### 7-2.2 Soldering Iron:

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. (Figure 2.)

- Preheat circuit and products to 150°C
- Never contact the ceramic with the iron tip
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- 350°C tip temperature (max)
- 1.0mm tip diameter (max)
- Limit soldering time to 4~5sec.

Fig.1 Soldering Reflow

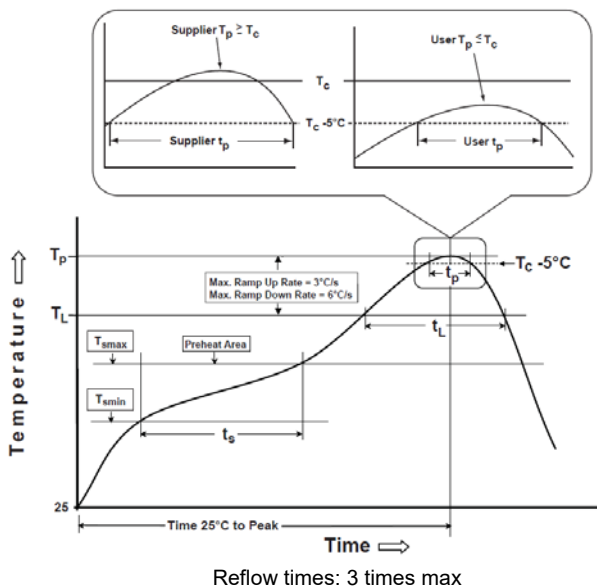
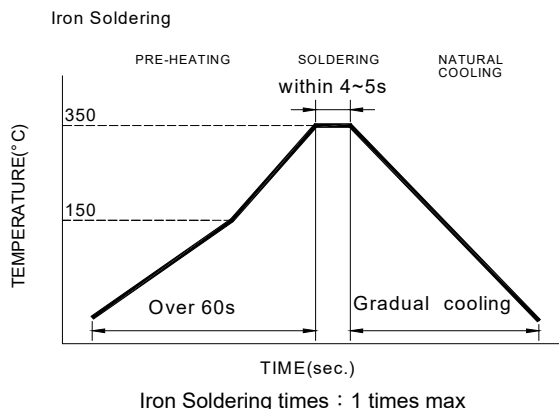


Fig.2 Iron soldering temperature profiles





**Table (1.1): Reflow Profiles**

Profile Type:	Pb-Free Assembly
Preheat -Temperature Min( $T_{smin}$ ) -Temperature Max( $T_{smax}$ ) -Time( $t_s$ )from( $T_{smin}$ to $T_{smax}$ )	150°C 200°C 60-120seconds
Ramp-up rate( $T_L$ to $T_p$ )	3°C/second max.
Liquidus temperature( $T_L$ ) Time( $t_L$ )maintained above $T_L$	217°C 60-150 seconds
Classification temperature( $T_c$ )	See Table (1.2)
Time( $t_p$ ) at $T_c - 5^\circ\text{C}$ ( $T_p$ should be equal to or less than $T_c$ .)	< 30 seconds
Ramp-down rate( $T_p$ to $T_L$ )	6°C /second max.
Time 25°C to peak temperature	8 minutes max.

$T_p$ : maximum peak package body temperature,  $T_c$ : the classification temperature.

For user (customer)  $T_p$  should be equal to or less than  $T_c$ .

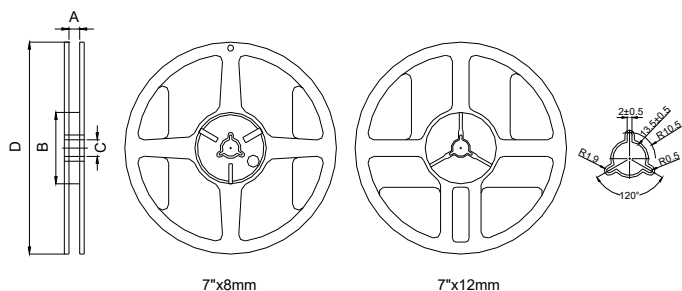
**Table (1.2) Package Thickness/Volume and Classification Temperature ( $T_c$ )**

	Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
PB-Free Assembly	<1.6mm	260°C	260°C	260°C
	1.6-2.5mm	260°C	250°C	245°C
	≥2.5mm	250°C	245°C	245°C

Reflow is referred to standard IPC/JEDEC J-STD-020E ◦

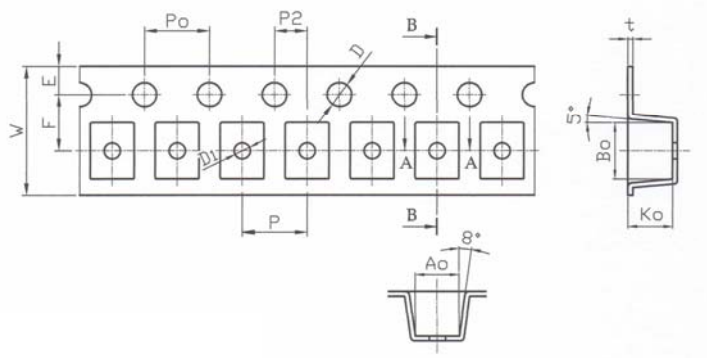
## 8. Packaging Information

### 8-1. Reel Dimension



Type	A(mm)	B(mm)	C(mm)	D(mm)
7"x8mm	9.0±0.5	60.0±2.0	13.5±0.5	178.0±2.0

### 8-2. Tape Dimension / 8mm

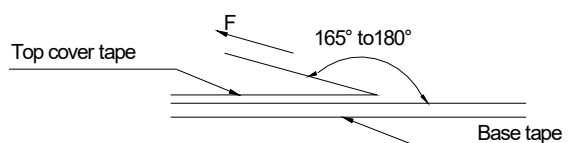


Series	P(mm)	Po(mm)	P2(mm)	Bo(mm)	Ao(mm)	Ko(mm)	W(mm)	t(mm)
APO	4.00±0.10	4.00±0.10	2.00±0.05	3.50±0.10	2.70±0.10	2.75±0.10	8.00±0.10	0.30±0.05

### 8-3. Packaging Quantity

APO	3225
Chip / Reel	1500
Reel Size	7"x8mm

### 8-4. Tearing Off Force



The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions.

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min
5~35	45~85	860~1060	300

#### Application Notice

- Storage Conditions(component level)  
To maintain the solderability of terminal electrodes:
  - TAI-TECH products meet IPC/JEDEC J-STD-020E standard-MSL, level 1.
  - Temperature and humidity conditions: Less than 40°C and 60% RH.
  - Recommended products should be used within 12 months form the time of delivery.
  - The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation
  - Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
  - The use of tweezers or vacuum pick up is strongly recommended for individual components.
  - Bulk handling should ensure that abrasion and mechanical shock are minimized.



# 測試報告 Test Report

號碼(No.): ETR23302694

日期(Date): 17-Mar-2023

頁數(Page): 1 of 15

西北臺慶科技股份有限公司 (TAI-TECH ADVANCED ELECTRONICS CO., LTD.)  
臺慶精密電子(昆山)有限公司 (TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO. LTD.)  
慶邦電子元件(泗洪)有限公司 (TAIPAQ ELECTRONICS (SI-HONG) CO., LTD.)  
桃園市楊梅區幼獅工業區幼四路1號 (NO. 1, YOU 4TH ROAD, YOUTH INDUSTRIAL DISTRICT, YANG-MEI, TAO-YUAN CITY, TAIWAN R. O. C.)  
江蘇省昆山市蓬朗昆嘉高科技工業區郭澤路 (GUO-ZE ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA)  
中國·江蘇省·宿遷市·泗洪縣·經濟開發區杭州路南側·建設北路東側 (THE SOUTH HANGZHOU ROAD AND THE EAST JIANSHE ROAD·ECONOMIC DEVELOPMENT ZONE·SIHONG COUNTY·SUQIANCITY·JIANGSU PROVINCE·P,R·CHINA)


以下測試樣品係由申請廠商所提供及確認 (The following sample(s) was/were submitted and identified by the applicant as) :

樣品名稱(Sample Name) : WIREWOUND SERIES  
樣品型號(Style/Item No.) : WCM(YCW) · WCL · HSF · HDMI · DVI · BCM · PCM · TCM · LCM · LPF · TXF · ACM · DCM(YLW) · WIH · BPH · TNH · YCM · STF · APO · QLL · FGO · APOC · TLAN SERIES

=====  
收件日(Sample Receiving Date) : 10-Mar-2023  
測試期間(Testing Period) : 10-Mar-2023 to 17-Mar-2023

測試需求(Test Requested) : 依據客戶要求進行測試·測試項目請參閱測試結果表格。(Testing item(s) is/are specified by client. Please refer to result table for testing item(s).)

測試結果(Test Results) : 請參閱下一頁 (Please refer to following pages.)

  
Troy Chang / Department Manager  
Signed for and on behalf of  
SGS TAIWAN LTD.  
Chemical Laboratory - Taipei



PIN CODE: 6621A826

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# 測試報告

## Test Report

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西北臺慶科技股份有限公司 (TAI-TECH ADVANCED ELECTRONICS CO., LTD.)

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### 測試部位敘述 (Test Part Description)

No.1 : 整體混測 (MIXED ALL PARTS)

### 測試結果 (Test Results)

測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
鎘 (Cd) (Cadmium (Cd))	參考IEC 62321-5: 2013 · 以感應耦合電漿發射光譜儀分析。(With reference to IEC 62321-5: 2013, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
鉛 (Pb) (Lead (Pb))	參考IEC 62321-5: 2013 · 以感應耦合電漿發射光譜儀分析。(With reference to IEC 62321-5: 2013, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
汞 (Hg) (Mercury (Hg))	參考IEC 62321-4: 2013+ AMD1: 2017 · 以感應耦合電漿發射光譜儀分析。(With reference to IEC 62321-4: 2013+ AMD1: 2017, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
六價鉻 Cr(VI) (Hexavalent Chromium Cr(VI))	參考IEC 62321-7-2: 2017 · 以紫外光-可見光分光光度計分析。(With reference to IEC 62321-7-2: 2017, analysis was performed by UV-VIS.)	mg/kg	8	n.d.

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# 測試報告

## Test Report

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
一溴聯苯 (Monobromobiphenyl)	參考IEC 62321-6: 2015 · 以氣相層析儀/質譜儀分析。(With reference to IEC 62321-6: 2015, analysis was performed by GC/MS.)	mg/kg	5	n.d.
二溴聯苯 (Dibromobiphenyl)		mg/kg	5	n.d.
三溴聯苯 (Tribromobiphenyl)		mg/kg	5	n.d.
四溴聯苯 (Tetrabromobiphenyl)		mg/kg	5	n.d.
五溴聯苯 (Pentabromobiphenyl)		mg/kg	5	n.d.
六溴聯苯 (Hexabromobiphenyl)		mg/kg	5	n.d.
七溴聯苯 (Heptabromobiphenyl)		mg/kg	5	n.d.
八溴聯苯 (Octabromobiphenyl)		mg/kg	5	n.d.
九溴聯苯 (Nonabromobiphenyl)		mg/kg	5	n.d.
十溴聯苯 (Decabromobiphenyl)		mg/kg	5	n.d.
多溴聯苯總和 (Sum of PBBs)		mg/kg	-	n.d.
一溴聯苯醚 (Monobromodiphenyl ether)		mg/kg	5	n.d.
二溴聯苯醚 (Dibromodiphenyl ether)		mg/kg	5	n.d.
三溴聯苯醚 (Tribromodiphenyl ether)		mg/kg	5	n.d.
四溴聯苯醚 (Tetrabromodiphenyl ether)		mg/kg	5	n.d.
五溴聯苯醚 (Pentabromodiphenyl ether)		mg/kg	5	n.d.
六溴聯苯醚 (Hexabromodiphenyl ether)		mg/kg	5	n.d.
七溴聯苯醚 (Heptabromodiphenyl ether)		mg/kg	5	n.d.
八溴聯苯醚 (Octabromodiphenyl ether)		mg/kg	5	n.d.
九溴聯苯醚 (Nonabromodiphenyl ether)		mg/kg	5	n.d.
十溴聯苯醚 (Decabromodiphenyl ether)		mg/kg	5	n.d.
多溴聯苯醚總和 (Sum of PBDEs)	mg/kg	-	n.d.	

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# 測試報告

## Test Report

號碼(No.): ETR23302694

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西北臺慶科技股份有限公司 (TAI-TECH ADVANCED ELECTRONICS CO., LTD.)

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
鄰苯二甲酸丁苯甲酯 (BBP) (Butyl benzyl phthalate (BBP))	參考IEC 62321-8: 2017, 以氣相層析儀/質譜儀分析。(With reference to IEC 62321-8: 2017, analysis was performed by GC/MS.)	mg/kg	50	n.d.
鄰苯二甲酸二丁酯 (DBP) (Dibutyl phthalate (DBP))		mg/kg	50	n.d.
鄰苯二甲酸二(2-乙基己基)酯 (DEHP) (Di-(2-ethylhexyl) phthalate (DEHP))		mg/kg	50	n.d.
鄰苯二甲酸二異丁酯 (DIBP) (Diisobutyl phthalate (DIBP))		mg/kg	50	n.d.
鄰苯二甲酸二異癸酯 (DIDP) (Diisodecyl phthalate (DIDP)) (CAS No.: 26761-40-0, 68515-49-1)		mg/kg	50	n.d.
鄰苯二甲酸二異壬酯 (DINP) (Diisononyl phthalate (DINP)) (CAS No.: 28553-12-0, 68515-48-0)		mg/kg	50	n.d.
鄰苯二甲酸二正辛酯 (DNOP) (Di-n-octyl phthalate (DNOP)) (CAS No.: 117-84-0)		mg/kg	50	n.d.
鄰苯二甲酸二正戊酯 (DNPP) (Di-n-pentyl phthalate (DNPP)) (CAS No.: 131-18-0)		mg/kg	50	n.d.
鄰苯二甲酸二正己酯 (DNHP) (Di-n-hexyl phthalate (DNHP)) (CAS No.: 84-75-3)		mg/kg	50	n.d.

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
六溴環十二烷及所有主要被辨別出的異構物(HBCDD) ( $\alpha$ - HBCDD, $\beta$ - HBCDD, $\gamma$ - HBCDD) (Hexabromocyclododecane (HBCDD) and all major diastereoisomers identified ( $\alpha$ - HBCDD, $\beta$ - HBCDD, $\gamma$ - HBCDD)) (CAS No.: 25637-99-4, 3194-55-6 (134237-51-7, 134237-50-6, 134237-52-8))	參考IEC 62321-9: 2021 · 以氣相層析儀/質譜儀分析。(With reference to IEC 62321-9: 2021, analysis was performed by GC/MS.)	mg/kg	20	n.d.
氟 (F) (Fluorine (F)) (CAS No.: 14762-94-8)	參考BS EN 14582: 2016 · 以離子層析儀分析。(With reference to BS EN 14582: 2016, analysis was performed by IC.)	mg/kg	50	n.d.
氯 (Cl) (Chlorine (Cl)) (CAS No.: 22537-15-1)		mg/kg	50	n.d.
溴 (Br) (Bromine (Br)) (CAS No.: 10097-32-2)		mg/kg	50	n.d.
碘 (I) (Iodine (I)) (CAS No.: 14362-44-8)		mg/kg	50	n.d.
全氟辛烷磺酸及其鹽類 (PFOS and its salts) (CAS No.: 1763-23-1 and its salts)	參考CEN/TS 15968: 2010 · 以液相層析串聯質譜儀分析。(With reference to CEN/TS 15968: 2010, analysis was performed by LC/MS/MS.)	mg/kg	0.01	n.d.
全氟辛酸及其鹽類 (PFOA and its salts) (CAS No.: 335-67-1 and its salts)		mg/kg	0.01	n.d.
銻 (Sb) (Antimony (Sb)) (CAS No.: 7440-36-0)	參考US EPA 3052: 1996 · 以感應耦合電漿發射光譜儀分析。(With reference to US EPA 3052: 1996, analysis was performed by ICP-OES.)	mg/kg	2	82.3
鈹 (Be) (Beryllium (Be)) (CAS No.: 7440-41-7)		mg/kg	2	n.d.

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
聚氯乙烯 (Polyvinyl chloride) (PVC)	參考ASTM E1252: 2021 · 以傅立葉轉換紅外線光譜儀及焰色法分析。(With reference to ASTM E1252: 2021, analysis was performed by FT-IR and Flame Test.)	**	-	Negative

### 備註(Note) :

1. mg/kg = ppm ; 0.1wt% = 0.1% = 1000ppm
2. MDL = Method Detection Limit (方法偵測極限值)
3. n.d. = Not Detected (未檢出) ; 小於MDL / Less than MDL
4. "-" = Not Regulated (無規格值)
5. \*\* = Qualitative analysis (No Unit) 定性分析(無單位)
6. Negative = Undetectable 陰性(未偵測到); Positive = Detectable 陽性(已偵測到)
7. 全氟辛烷磺酸及其鹽類包含等物質 (PFOS and its salts including) :  
CAS No.: 1763-23-1, 2795-39-3, 29457-72-5, 29081-56-9, 70225-14-8, 56773-42-3, 251099-16-8, 307-35-7, 91036-71-4, 4021-47-0 and others.
8. 全氟辛酸及其鹽類包含等物質 (PFOA and its salts including) :  
CAS No.: 335-67-1, 335-95-5, 2395-00-8, 335-93-3, 335-66-0, 3825-26-1 and others.
9. 樣品的測試是基於申請人要求混合測試 · 報告中的混合測試結果不代表其中個別單一材質的含量。  
The sample(s) was/were analyzed on behalf of the applicant as mixing sample in one testing. The above result(s) was/were only given as the informality value.

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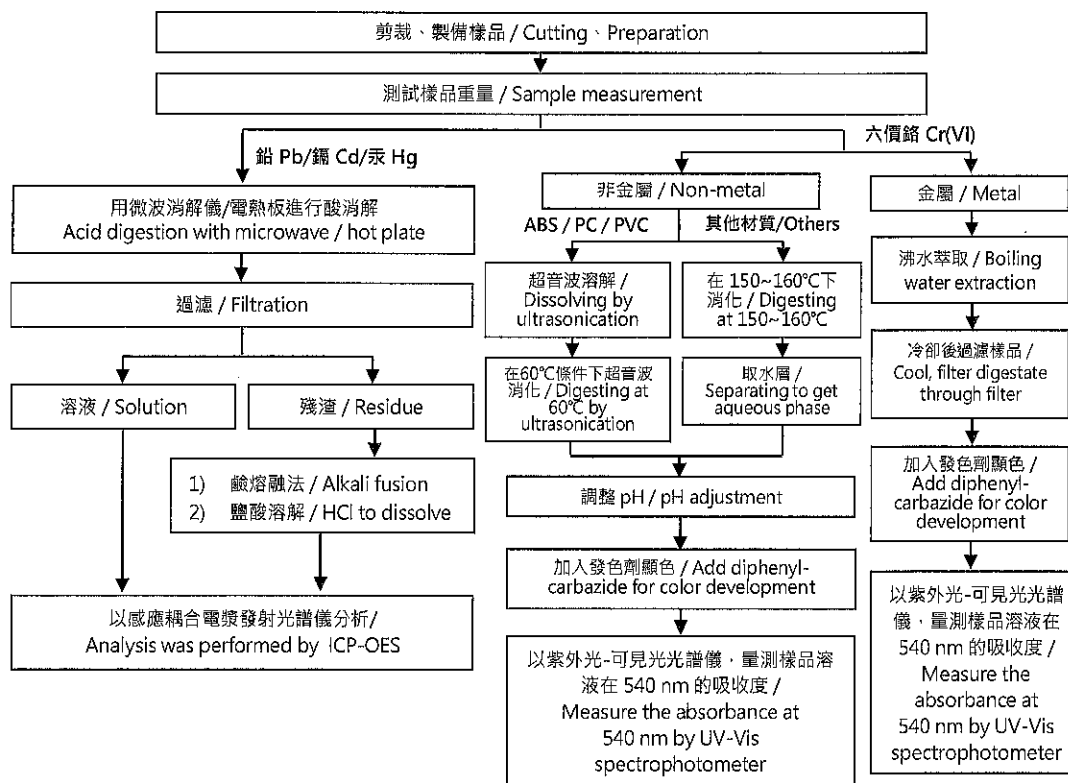
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### 重金屬流程圖 / Analytical flow chart of heavy metal

根據以下的流程圖之條件·樣品已完全溶解。(六價鉻測試方法除外)

These samples were dissolved totally by pre-conditioning method according to below flow chart.

(Cr<sup>6+</sup> test method excluded)



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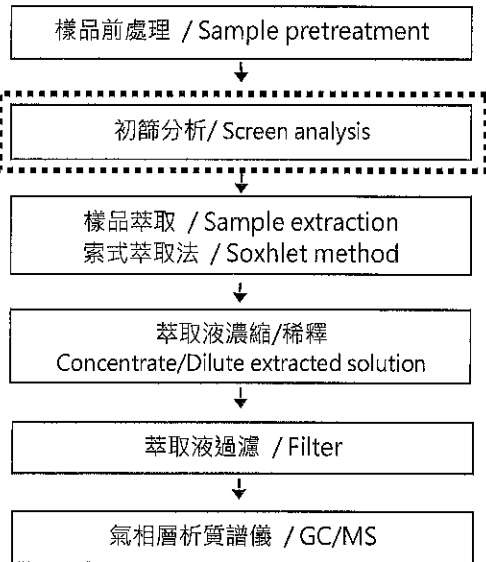
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### 多溴聯苯/多溴聯苯醌分析流程圖 / Analytical flow chart - PBBs/PBDEs

- 初次測試程序 / First testing process      —————→
- 選擇性篩檢程序 / Optional screen process      ······→
- 確認程序 / Confirmation process      - - - - -→



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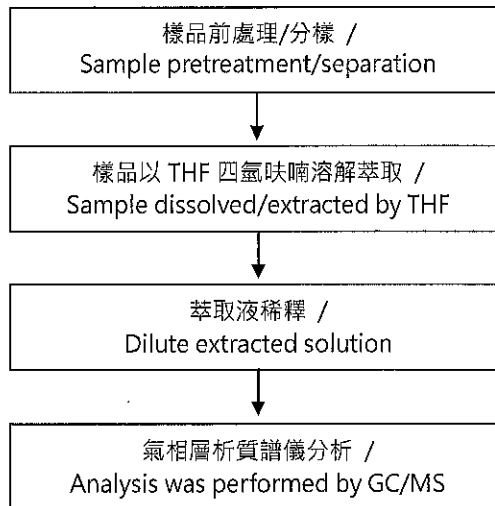
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## 可塑劑分析流程圖 / Analytical flow chart - Phthalate

【測試方法/Test method: IEC 62321-8】



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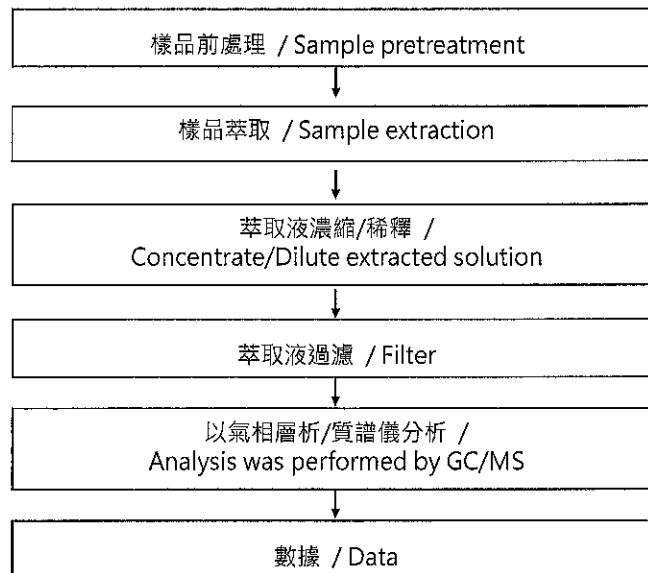
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### 六溴環十二烷分析流程圖 / Analytical flow chart - HBCDD



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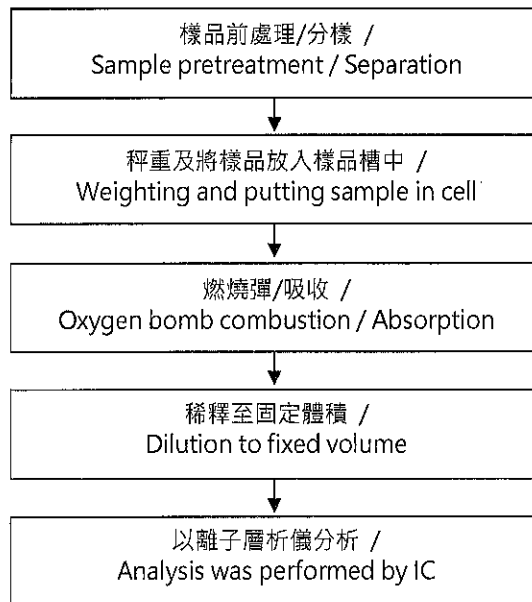
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### 鹵素分析流程圖 / Analytical flow chart - Halogen



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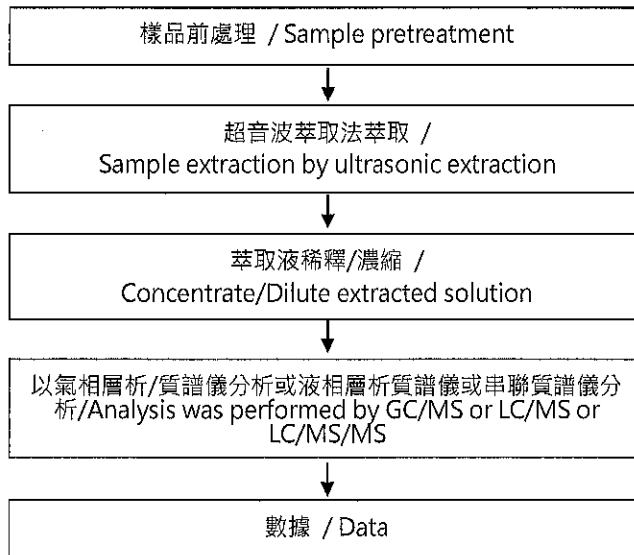
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### 全氟化合物(包含全氟辛酸/全氟辛烷磺酸/其相關化合物等等)分析流程圖 / Analytical flow chart – PFAS (including PFOA/PFOS/its related compound, etc.)



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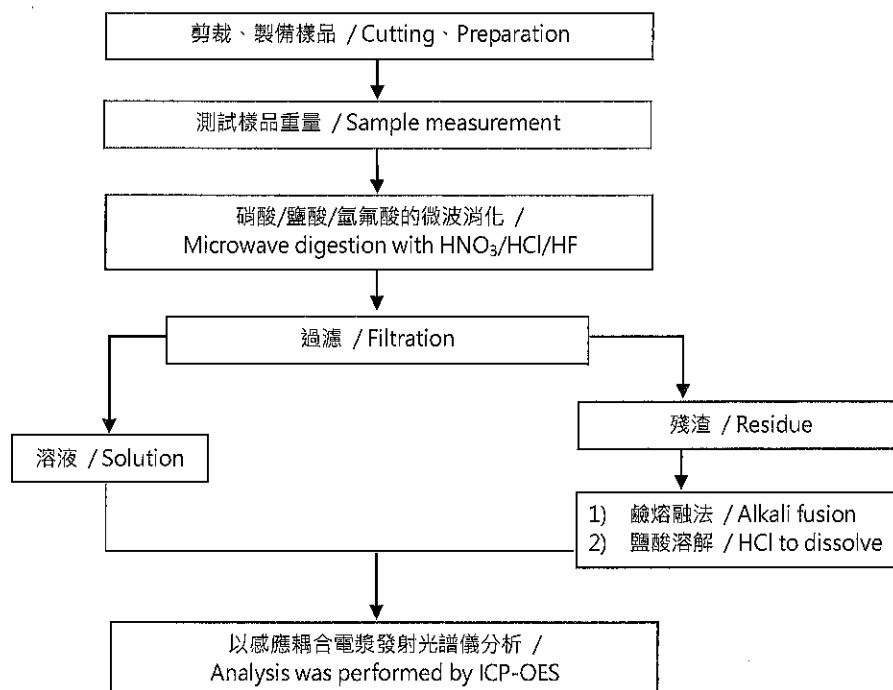
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## 元素(含重金屬)分析流程圖 / Analytical flow chart of elements (Heavy metal included)

根據以下的流程圖之條件·樣品已完全溶解·

These samples were dissolved totally by pre-conditioning method according to below flow chart.

【參考方法/Reference method : US EPA 3051A · US EPA 3052】



\* US EPA 3051A 方法未添加氫氟酸 / US EPA 3051A method does not add HF.

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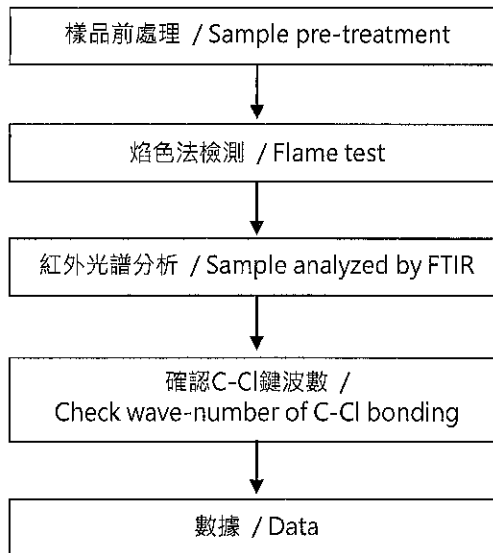
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### 聚氯乙炔物質判定分析流程圖 / Analysis flow chart - PVC



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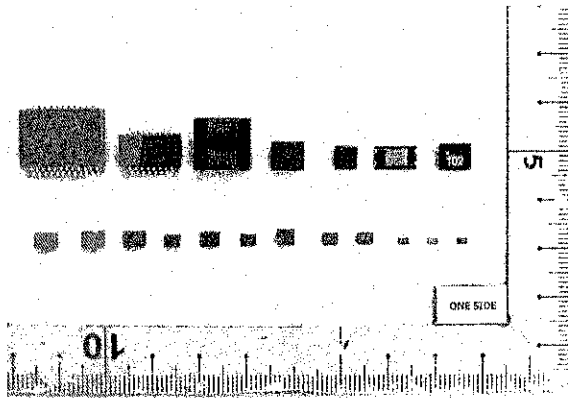
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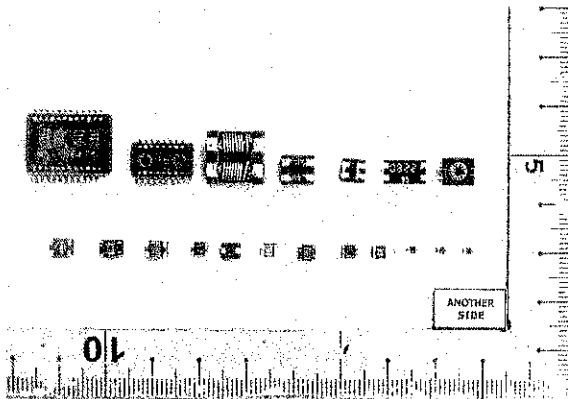
\* 照片中如有箭頭標示，則表示為實際檢測之樣品/部位。\*

(The tested sample / part is marked by an arrow if it's shown on the photo.)

### ETR23302694



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